# R15IQ3S-EHC3

## 15" Qualcomm Snapdragon™ 660 E Series HMI Panel PC



#### **KEY FEATURES**

- 15" 1024 x 768 Resolution with Projected Capacitive Multi-Touch (P-CAP)
- Qualcomm Snapdragon<sup>™</sup> 660 octa-core, 2.2 GHz CPU
- Fanless cooling system and ultra-low power consumption
- Front IP65 Water and Dust Proof



#### **SPECIFICATIONS**

Dienlay

Display			
Resolution	1024x768	Size	15.0 inches
Contrast Ratio	2000:1	Panel Brightness	300.0 nits
View Angles	88,88,88,88	Active Area	304.1x228.1 mm
Touch / Glass	Projected Capacitive Multi Touch Screen		
System Specificat	ion		
WLAN	Support (Optional)	ВТ	Support (Optional)
Processor	Qualcomm® Snapdragon™ 660 (Octa-Core 2.2 GHz)	Memory	3GB LPDDR4
Storage	eMMC: Onboard 32 GB	Operating System	Android 9.0
Mechanical			
Dimension	367 x 291 x 65.8 mm	Weight	3.0 kg
Mounting	Panel Mount VESA Mount	Enclosure	Metal Front Bezel with Plastic Back Cover
Cooling System	Fanless Design	Cut out	342x261mm
Environment			
Operating Humidity	10% to 90% RH, Non-Condensing	Operating Temperature	0°C to 50°C
Storage Temperature	-20°C to 60°C	Shock	MIL-STD-810G Method 516.6 Procedure I
Vibration	MIL-STD-810G Method 514.6 Procedure I	IP rating	Front IP65
Certification			
Certification	CE, FCC		
IO Ports			
USB Port	2 x USB 2.0 (Type A), 1 x USB 3.0 (Type-C)	Serial Port	1 x RS232/422/485 (Default RS232)
SD Card Slot	1 x Micro SD card slot	Video	1 x Micro HDMI (Optional)
LAN	1 x LAN PoE at/af (Optional)		
Accessory			
Accessory	100~240V AC to DC Adapter Power Cord		

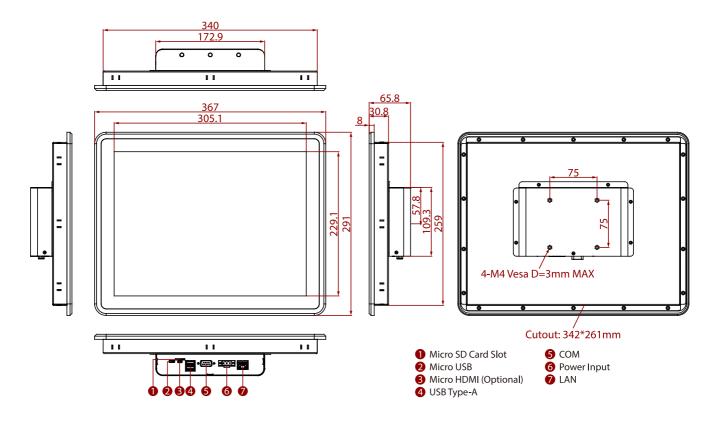
VESA screws Manual Mounting clips

Power

Power Rating 12V DC with Terminal Block Adapter 12V 50W

#### **DIMENSIONS**

UNIT:MM



### **NOTE**

- 1. This is a simplified drawing and some components are not marked in detail.
- 2. The product shown in this datasheet is a standard model. For diagrams that contain customized or optional I/O, please contact the Winmate Sales Team for more information.
- 3. All specifications are subject to change without prior notice.